FORM P (Rev. 6-93)		LEI U.S. Department of Commerce		
OMP No. 0	651-0011 (exp. 4/94)			
·	To the Honorable Commissioner of Patents and Trademarks:	8842  Please record the attached original documents or copy thereof.		
1.	Name of conveying party(ies):			
	(1) Mark A. KAMPE; (2) Frederic HERRMANN; (3) Gia-Khanh NGUYEN; (4) Frederic BARRAT; (5) Ramachandra BETHMANGALKAR; and (6) Ravi CHITLOOR	2. Name and address of receiving party(ies)  Name: Sun Microsystems, Inc.  Street address: 901 San Antonio Road Palo Alto, CA 94303		
Additional name(s) of conveying party(ies) attached?  Yes No		Additional name(s) & address(es) attached?  Yes No		
3.	Nature of conveyance:			
		09246250		
4.	Application number(s) or patent number(s):  If this document is being filed together with a new application.	ion, the execution date of the application is: April 30, 2001		
	A. Patent Application No.	B. Patent No.(s)		
	Attorney Docket No.: 80168-0103	D. Fatche 110.(5)		
	Client Matter No.P5087			
Additional numbers attached?  Yes No				
5.	Name and Address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved: 1		
	Name: Matthew T. Bailey Internal Address: Hogan & Hartson LLP Street Address: Columbia Square 555 Thirteenth Street, N.W. City: Washington State: D.C. Zip: 20004-1109	7. Total fee (37 CFR 3.41)\$ _40.00  ⊠ Enclosed □ Authorized to be charged to deposit account		
		8. Deposit account number:		
		50-1349 (Attach duplicate copy of this page if paying by deposit account)		
	DO NOT USE	THIS SPACE		
9.	Statement and signature.  To the best of my knowledge and belief, the foregoing inforthe original document.  Matthew T. Bailey, Reg. No. 33,829  Name of Person signing  Total number of pages including cover	May 2, 2001  Date  Sheet, attachments and document:4		
	Mail documents to be recorded with Commissioner of Patents & T			

\\DC - 80168/103 - #1313587 v1

## ASSIGNMENT

WHEREAS we, the below named inventors [hereinafter referred to as Assignors], have made an invention entitled:

## CLUSTER CONFIGURATION REPOSITORY

for which an application for United States Letters Patent is filed herewith;

AND WHEREAS, SUN MICROSYSTEMS, INC., a corporation of the State of Delaware, whose post office address is 901 San Antonio Road, MS-PAL01-521, Palo Alto, California 94303, [hereinafter referred to as Assignee], is desirous of securing the entire right, title and interest in and to this invention in all countries throughout the world, and in and to the application for United States Letters Patent on this invention and the Letters Patent to be issued upon this application;

NOW, THEREFORE, be it known that, for and in consideration of the sum of one dollar (\$1.00) in hand paid and other good and valuable consideration the receipt of which from assignee, is hereby acknowledged, we, as assignors, have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, our entire right, title and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof, and all rights to claim priority on the basis of such application, and all applications for Letters patent which may hereafter be filed for this invention in any foreign country and all Letters Patent which may be granted on this invention in any foreign country, and all extensions, renewals and reissues thereof; and we hereby authorize and request the Commissioner of Patents and Trademarks of the United States and any official of any foreign country whose duty it is to issue patents on applications as described above, to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, we HEREBY covenant that we have the full right to convey the interest assigned by this Assignment, and we have not executed and will not execute any agreement in conflict with this Assignment;

AND WE HEREBY further convenant and agree that we will, without further consideration, communicate with assignee, its successors and assigns, any facts known to us respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors or assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by assignees, it successors and assigns.

IN TESTIMONY WHEREOF, we have hereunto set our hands.

Mark A. KAMPE

Full Name of Sole or First Inventor

Sun Microsystems, Inc., 6601 Center Drive West

Los Angeles, CA 90045

Assignor's Signature

Data

Names of additional inventors attached [X]Y []N

\\DC - 80168/105 - #1312790 v1

PATENT REEL: 011778 FRAME: 0008

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Gia-Khanh NGUYEN Full Name of Third Inventor  Sun Microsystems, Inc., 16 Network Circle MPK 18-202, Menlo Park, CA 94025  Assignor's Signature  4 (30 0)  Date	
Frederic BARRAT Full Name of Fourth Inventor  Sun Microsystems, Inc., 16 Network Circle MPK 16-202, Mento Park, CA 94025  Assignor's Signature  4/30/01  Date	- Maria

Attorney Docket No. 80168-0103 Sole/Joint Invention (Worldwide Rights) Page 3

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Names of additional inventors attached [ ] Y [X] N

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**PATENT** REEL: 011778 FRAME: 0010